

# WG50N65HAW1

Rev.02 - 22 November 2024

**IGBT** 

**Product data sheet** 

### 1. General description

WG50N65HAW1 uses advanced Fine Trench Field-stop IGBT technology with antiparallel diode in TO247 package to provide extremely low Vce(sat), and excellent switching performance. This device offers Best-in-Class efficiency in hard switching and resonant topology.



### 2. Features and benefits

- Maximum junction temperature 175 °C
- · Positive temperature efficient for easy paralleling
- Very soft, fast recovery anti-parallel diode
- High speed switching
- EMI Improved Design

#### 3. Applications

- PFC
- Solar converters
- UPS
- Welding Converters
- · Mid to high range switching frequency converters

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Parameter		Value			Unit
$V_{CE}$	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$			650			V
I <sub>c</sub>	DC collector current, limited by $T_{j(max)}$ T <sub>c</sub> = 100 °C				50		А
Symbol	Parameter Conditions			Min	Тур	Мах	Unit
Static cha	racteristics						
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 25 °C		-	1.6	2.1	V

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		•C
2	С	collector		1 A
3	E	emitter		
mb	C	mounting base; connected to collector		G E sym200

# 6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WG50N65HAW1	TO247	WG50N65HAW1Q	Tube	30	TO247P	09-Mar-2023		

## 7. Marking

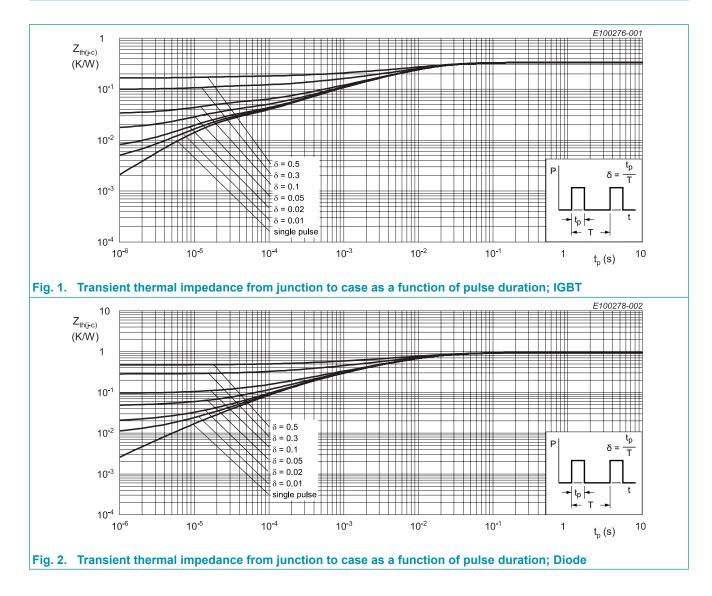
Table 4. Marking codes		
Type number	Marking codes	
WG50N65HAW1	G50N65	
	HAW1	

# 8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V <sub>CE</sub>	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$		650	V
I <sub>c</sub>	DC collector current, limited by $T_{j(max)}$ $T_c = 25 \text{ °C}$ $T_c = 100 \text{ °C}$		100 50	A
I <sub>C(puls)</sub>	Pulsed collector current, $t_{\rm p}$ limited by $T_{j(\text{max})}$		150	А
-	Turn off safe operating area $V_{CE} \le 650 \text{ V}, \text{ T}_{j} \le 175 \text{ °C}, \text{ t}_{p} = 1 \mu\text{s}$		150	A
I <sub>F</sub>	Diode forward current, limited by $T_{j(max)}$ $T_{c} = 25 \text{ °C}$ $T_{c} = 100 \text{ °C}$		60 30	A
I <sub>Fpuls</sub>	Diode pulsed current, $t_{\rm p}$ limited by $T_{j(\text{max})}$		90	А
V <sub>GE</sub>	Gate-emitter voltage		±20	V
P <sub>tot</sub>	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		454 227	W
T <sub>stg</sub>	Storage temperature		-55 to 150	°C
T <sub>jmax</sub>	Maximum operating junction temperature		175	°C
_	Peak soldering temperture		260	°C
М	Mounting Torque with washer		0.55	Nm

## 9. Thermal characteristics

Table 6. Th	Table 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
R <sub>th(j-c)</sub>	IGBT thermal resistance from junction to case			-	0.33	-	K/W	
R <sub>th(j-c)</sub>	Diode thermal resistance from junction to case			-	0.94	-	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient			-	40	-	K/W	

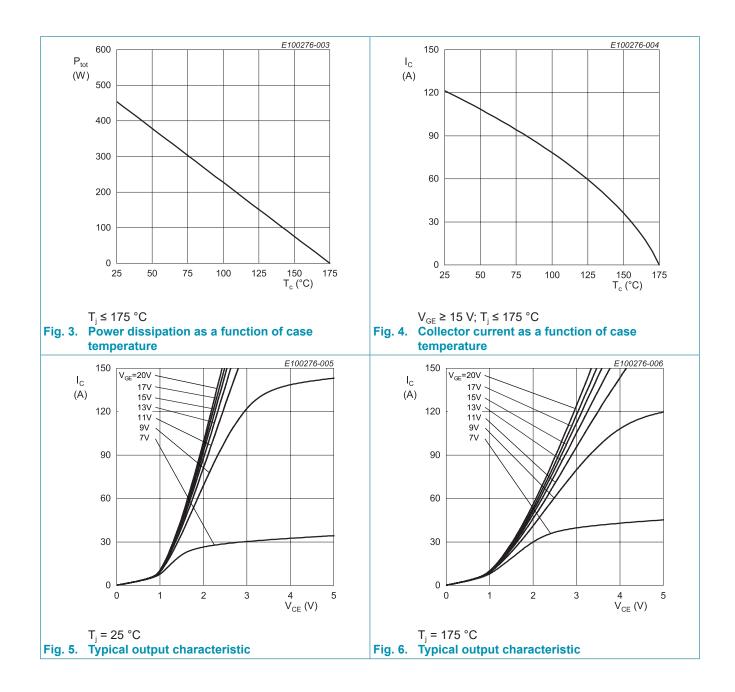


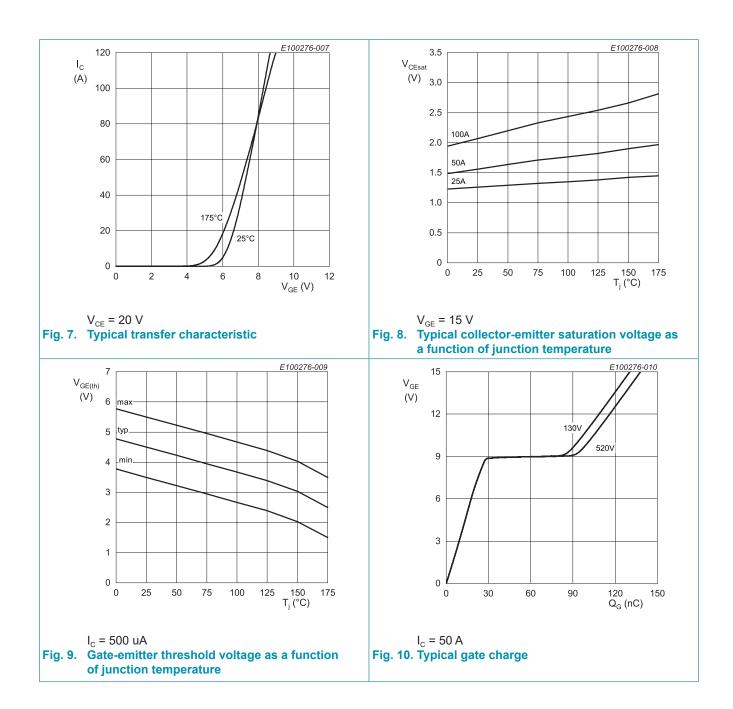
## **10. Characteristics**

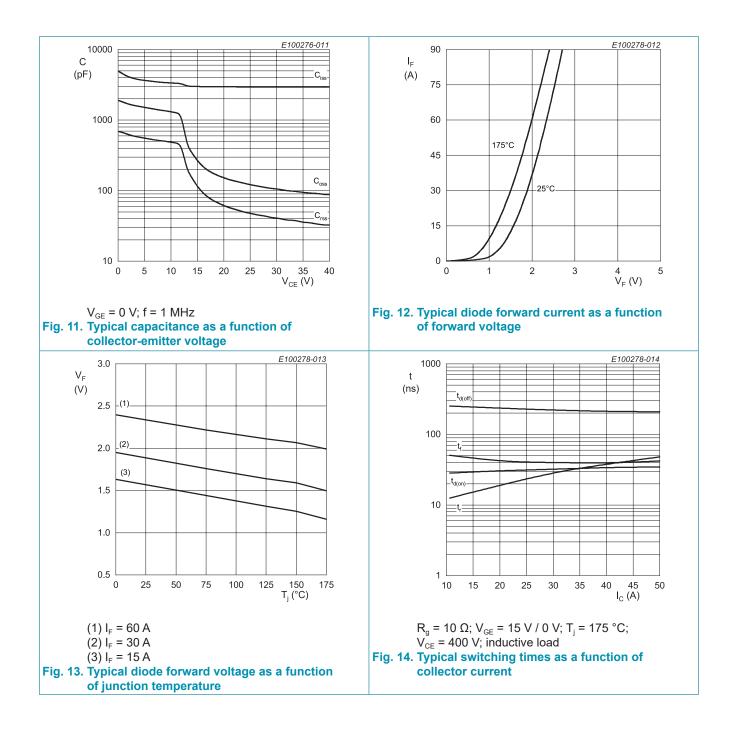
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
$BV_{CES}$	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}; \text{ I}_{C} = 1 \text{ mA}$		650	-	-	V
V <sub>CE(sat)</sub>	Collector-emitter saturation	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 25 °C		-	1.6	2.1	V
	voltage	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 175 °C		-	1.95	-	V
V <sub>F</sub>	Diode forward voltage	V <sub>GE</sub> = 0 V; I <sub>F</sub> = 30 A; T <sub>j</sub> = 25 °C		-	1.9	-	V
		V <sub>GE</sub> = 0 V; I <sub>F</sub> = 30 A; T <sub>j</sub> = 175 °C		-	1.5	-	V
V <sub>GE(th)</sub>	Gate-emitter threhold voltage	$I_{\rm C}$ = 500 uA; $V_{\rm CE}$ = $V_{\rm GE}$		3.5	4.5	5.5	V
I <sub>CES</sub>	Zero gate voltage collector current	$V_{CE}$ = 650 V; $V_{GE}$ = 0 V; $T_{j}$ = 25 °C		-	-	100	uA
		$V_{CE}$ = 650 V; $V_{GE}$ = 0 V; $T_{j}$ = 175 °C		-	-	1	mA
<b>g</b> <sub>fs</sub>	Transconductance	V <sub>CE</sub> = 20 V; I <sub>C</sub> = 50 A		-	47	-	S
Dynamic	characteristics	1					
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> = 30 V; V <sub>GE</sub> = 0V; f = 1 MHz;		-	2955	-	pF
C <sub>oes</sub>	Output capacitance	T <sub>j</sub> = 25 °C		-	105	-	pF
C <sub>res</sub>	Reverse transfer capacitance			-	41	-	pF
Q <sub>G</sub>	Gate charge	V <sub>cc</sub> = 520 V; I <sub>c</sub> = 50 A; V <sub>GE</sub> = 15 V; T <sub>i</sub> = 25 °C		-	138	-	nC

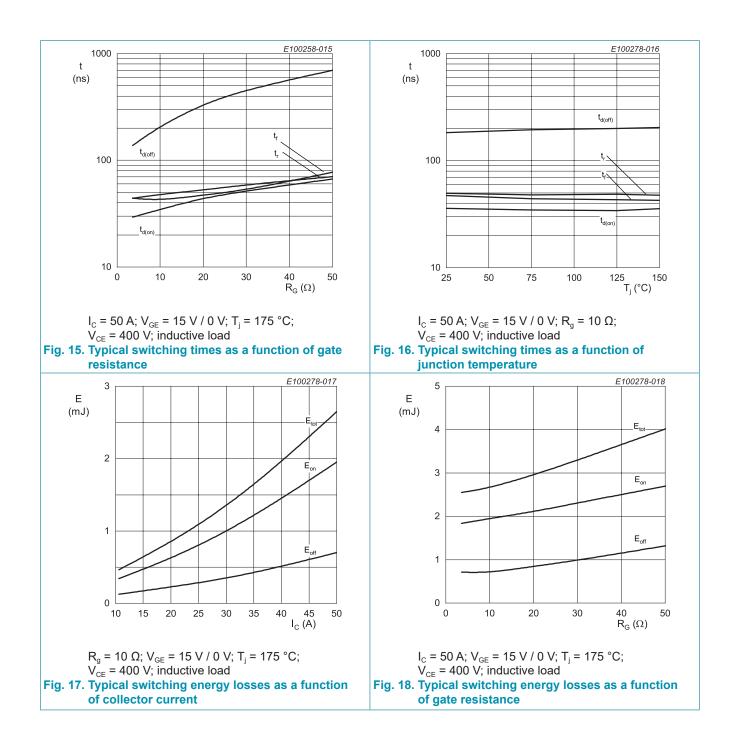
# **11. Switching Characteristics**

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
IGBT cha	acteristics						
t <sub>d(on)</sub>	Turn-on delay time	T <sub>j</sub> = 25 °C;		-	36	-	nS
t <sub>r</sub>	Rise time	$V_{cc} = 400 \text{ V}; \text{ I}_{c} = 50 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V};$ R <sub>G</sub> = 10 ohm		-	50	-	nS
$t_{\rm d(off)}$	Turn-off delay time			-	188	-	nS
t <sub>f</sub>	Fall time			-	47	-	nS
Eon	Turn-on energy			-	1.3	-	mJ
E <sub>off</sub>	Turn-off energy			-	0.6	-	mJ
E <sub>ts</sub>	Total switching energy			-	1.9	-	mJ
t <sub>d(on)</sub>	Turn-on delay time	$T_j = 175 \text{ °C};$ $V_{cc} = 400 \text{ V}; I_c = 50 \text{ A}; V_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_G = 10 \text{ ohm}$		-	34	-	nS
t <sub>r</sub>	Rise time			-	47	-	nS
$t_{d(off)}$	Turn-off delay time			-	214	-	nS
t <sub>f</sub>	Fall time			-	42	-	nS
E <sub>on</sub>	Turn-on energy			-	1.95	-	mJ
E <sub>off</sub>	Turn-off energy			-	0.7	-	mJ
E <sub>ts</sub>	Total switching energy			-	2.65	-	mJ
Diode cha	racteristics			,	-		
t <sub>rr</sub>	Reverse recovery time	$T_j = 25 °C;$		-	44	-	nS
Q <sub>r</sub>	Reverse recovery charge	$V_{R} = 400 \text{ V}; \text{ I}_{F} = 30 \text{ A}; \text{ dI}_{F}/\text{dt} = 500 \text{ A}/\text{us}$		-	221	-	nC
I <sub>RM</sub>	Reverse recovery peak current			-	9	-	A
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 175 °C;		-	100	-	nS
Q <sub>r</sub>	Reverse recovery charge	$V_{R} = 400 \text{ V}; \text{ I}_{F} = 30 \text{ A}; \text{ dI}_{F}/\text{dt} = 500 \text{ A}/\text{us}$		-	990	-	nC
I <sub>RM</sub>	Reverse recovery peak current			-	17	-	А



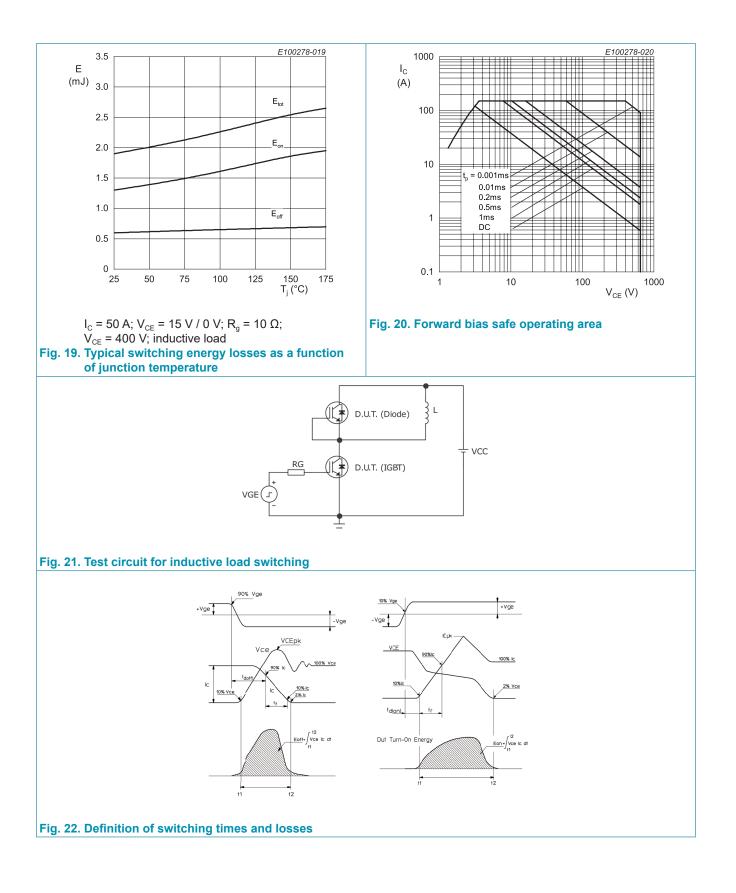




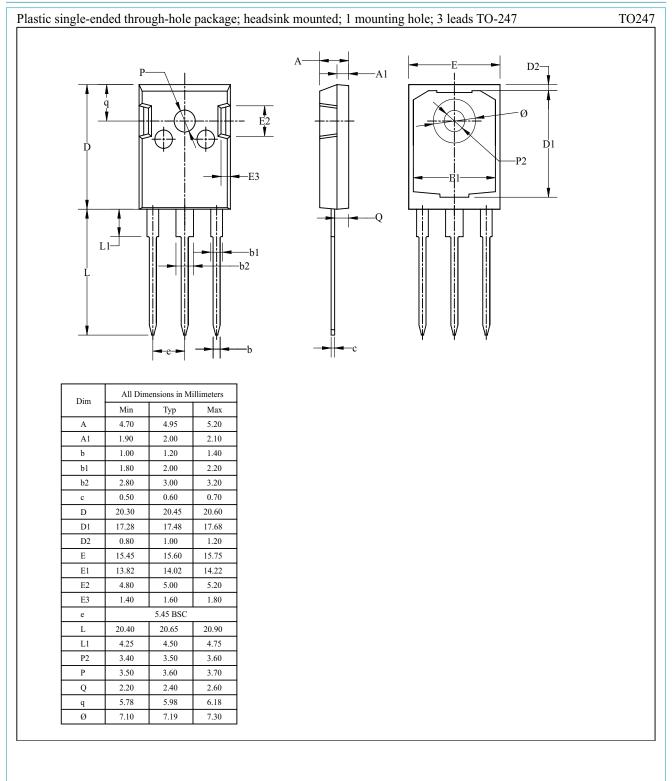


#### **WeEn Semiconductors**





### 12. Package outline



# WG50N65HAW1

# 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### 14. Contents

1. General description	1
2. Features and benefits	1
3. Applications	1
4. Quick reference data	1
5. Pinning information	2
6. Ordering information	2
7. Marking	2
8. Limiting values	3
9. Thermal characteristics	4
10. Characteristics	5
11. Switching Characteristics	6
12. Package outline	12
13. Legal information	13
14. Contents	15

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